

SKM150GB17E4G



SEMITRANS® 3

IGBT4 Modules

SKM150GB17E4G

Features

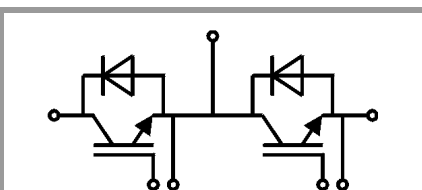
- IGBT4 = 4. generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4. Generation CAL-Diode
- Insulated copper baseplate using DBC Technology (Direct Copper Bonding)
- With integrated Gate resistor
- For switching frequencies up to 8kHz
- UL recognized, file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic welders
- Wind power
- Public transport

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max.
- Recommended $T_{op} = -40 \dots +150^\circ\text{C}$
- Product reliability results valid for $T_j = 150^\circ\text{C}$



GB

Absolute Maximum Ratings

| Symbol | Conditions | Values | Unit | |
|----------------------|---|---------------------------|------------------|---------------|
| IGBT | | | | |
| V_{CES} | $T_j = 25^\circ\text{C}$ | 1700 | V | |
| I_C | $T_j = 175^\circ\text{C}$ | $T_c = 25^\circ\text{C}$ | 242 | A |
| | | $T_c = 80^\circ\text{C}$ | 187 | A |
| I_{Cnom} | | 150 | A | |
| I_{CRM} | $I_{CRM} = 3 \times I_{Cnom}$ | 450 | A | |
| V_{GES} | | -20 ... 20 | V | |
| t_{psc} | $V_{CC} = 1000\text{ V}$ $V_{GE} \leq 15\text{ V}$ $V_{CES} \leq 1700\text{ V}$ | $T_j = 150^\circ\text{C}$ | 10 | μs |
| T_j | | -40 ... 175 | $^\circ\text{C}$ | |
| Inverse diode | | | | |
| V_{RRM} | $T_j = 25^\circ\text{C}$ | 1700 | V | |
| I_F | $T_j = 175^\circ\text{C}$ | $T_c = 25^\circ\text{C}$ | 163 | A |
| | | $T_c = 80^\circ\text{C}$ | 121 | A |
| I_{Fnom} | | 150 | A | |
| I_{FRM} | $I_{FRM} = 2 \times I_{Fnom}$ | 300 | A | |
| I_{FSM} | $t_p = 10\text{ ms}$, $\sin 180^\circ$, $T_j = 25^\circ\text{C}$ | 918 | A | |
| T_j | | -40 ... 175 | $^\circ\text{C}$ | |
| Module | | | | |
| $I_{t(RMS)}$ | | 500 | A | |
| T_{stg} | | -40 ... 125 | $^\circ\text{C}$ | |
| V_{isol} | AC sinus 50 Hz, $t = 1\text{ min}$ | 4000 | V | |

Characteristics

| Symbol | Conditions | min. | typ. | max. | Unit |
|---------------|---|---------------------------|-------|-------|------------------|
| IGBT | | | | | |
| $V_{CE(sat)}$ | $I_C = 150\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel | $T_j = 25^\circ\text{C}$ | 1.90 | 2.21 | V |
| | | $T_j = 150^\circ\text{C}$ | 2.35 | 2.60 | V |
| V_{CE0} | chipelevel | $T_j = 25^\circ\text{C}$ | 0.80 | 0.90 | V |
| | | $T_j = 150^\circ\text{C}$ | 0.70 | 0.80 | V |
| r_{CE} | $V_{GE} = 15\text{ V}$ chipelevel | $T_j = 25^\circ\text{C}$ | 7.3 | 8.7 | $\text{m}\Omega$ |
| | | $T_j = 150^\circ\text{C}$ | 11 | 12 | $\text{m}\Omega$ |
| $V_{GE(th)}$ | $V_{GE} = V_{CE}$, $I_C = 6\text{ mA}$ | 5.2 | 5.8 | 6.4 | V |
| I_{CES} | $V_{GE} = 0\text{ V}$, $V_{CE} = 1700\text{ V}$, $T_j = 25^\circ\text{C}$ | | | 2.0 | mA |
| C_{ies} | $V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$ | $f = 1\text{ MHz}$ | 13.6 | | nF |
| C_{oes} | | $f = 1\text{ MHz}$ | 0.53 | | nF |
| C_{res} | | $f = 1\text{ MHz}$ | 0.44 | | nF |
| Q_G | $V_{GE} = -8\text{ V} \dots +15\text{ V}$ | | 1200 | | nC |
| R_{Gint} | $T_j = 25^\circ\text{C}$ | | 4.3 | | Ω |
| $t_{d(on)}$ | $V_{CC} = 1200\text{ V}$ $I_C = 150\text{ A}$ | $T_j = 150^\circ\text{C}$ | 205 | | ns |
| t_r | $V_{GE} = +15/-15\text{ V}$ | $T_j = 150^\circ\text{C}$ | 23.5 | | ns |
| E_{on} | $R_{Gon} = 1\ \Omega$ | $T_j = 150^\circ\text{C}$ | 39 | | mJ |
| $t_{d(off)}$ | $R_{Goff} = 1\ \Omega$ | $T_j = 150^\circ\text{C}$ | 550 | | ns |
| t_f | | $T_j = 150^\circ\text{C}$ | 150 | | ns |
| E_{off} | | $T_j = 150^\circ\text{C}$ | 59 | | mJ |
| $R_{th(j-c)}$ | per IGBT | | | 0.161 | K/W |
| $R_{th(c-s)}$ | per IGBT ($\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$) | | 0.064 | | K/W |



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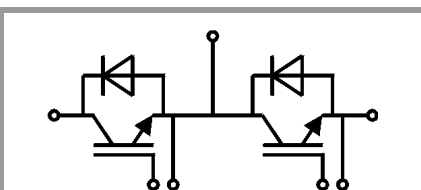
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Remarks

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| Characteristics | | | | | | |
|----------------------|--|---------------------------|------|-------|-------|---------------|
| Symbol | Conditions | | min. | typ. | max. | Unit |
| Inverse diode | | | | | | |
| $V_F = V_{EC}$ | $I_F = 150\text{ A}$ $V_{GE} = 0\text{ V}$ chipllevel | $T_j = 25^\circ\text{C}$ | | 2.00 | 2.40 | V |
| | | $T_j = 150^\circ\text{C}$ | | 2.14 | 2.56 | V |
| V_{F0} | chipllevel | $T_j = 25^\circ\text{C}$ | | 1.32 | 1.56 | V |
| | | $T_j = 150^\circ\text{C}$ | | 1.08 | 1.22 | V |
| r_F | chipllevel | $T_j = 25^\circ\text{C}$ | | 4.5 | 5.6 | m Ω |
| | | $T_j = 150^\circ\text{C}$ | | 7.1 | 9.0 | m Ω |
| I_{RRM} | $I_F = 150\text{ A}$ | $T_j = 150^\circ\text{C}$ | | 185 | | A |
| Q_{rr} | $V_{GE} = \pm 15\text{ V}$ $V_{CC} = 1200\text{ V}$ | $T_j = 150^\circ\text{C}$ | | 49 | | μC |
| E_{rr} | | $T_j = 150^\circ\text{C}$ | | 33 | | mJ |
| $R_{th(j-c)}$ | per diode | | | | 0.356 | K/W |
| $R_{th(c-s)}$ | per diode ($\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$) | | | 0.072 | | K/W |
| Module | | | | | | |
| L_{CE} | | | | 15 | | nH |
| R_{CC+EE} | measured per switch | $T_c = 25^\circ\text{C}$ | | 0.55 | | m Ω |
| | | $T_c = 125^\circ\text{C}$ | | 0.85 | | m Ω |
| $R_{th(c-s)1}$ | calculated without thermal coupling ($\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$) | | | 0.017 | | K/W |
| | including thermal coupling, Ts underneath module ($\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$) | | | 0.027 | | K/W |
| M_s | to heat sink M6 | | 3 | | 5 | Nm |
| M_t | | | 2.5 | | 5 | Nm |
| | to terminals M6 | | | | | |
| w | | | | | 325 | g |



GB

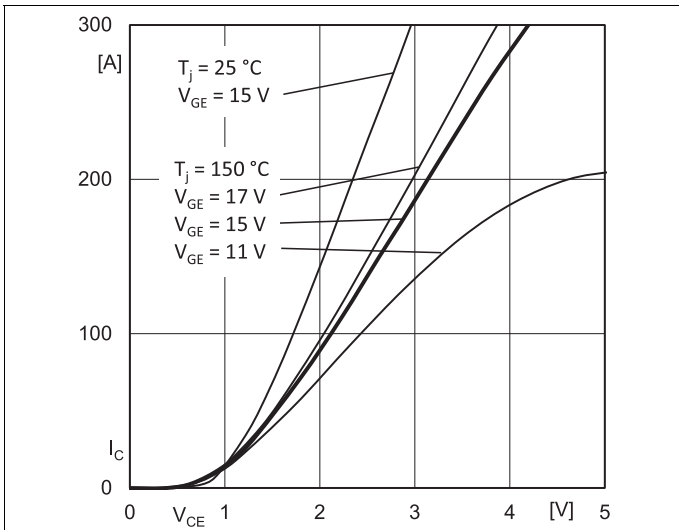


Fig. 1: Typ. output characteristic, inclusive $R_{CC'+EE'}$

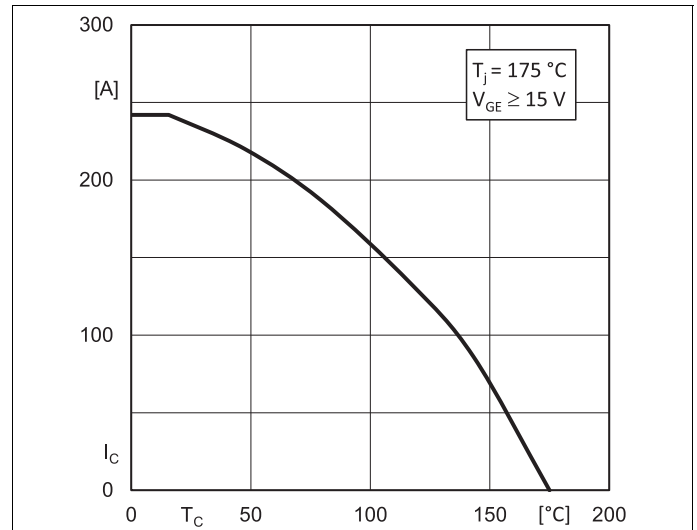


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

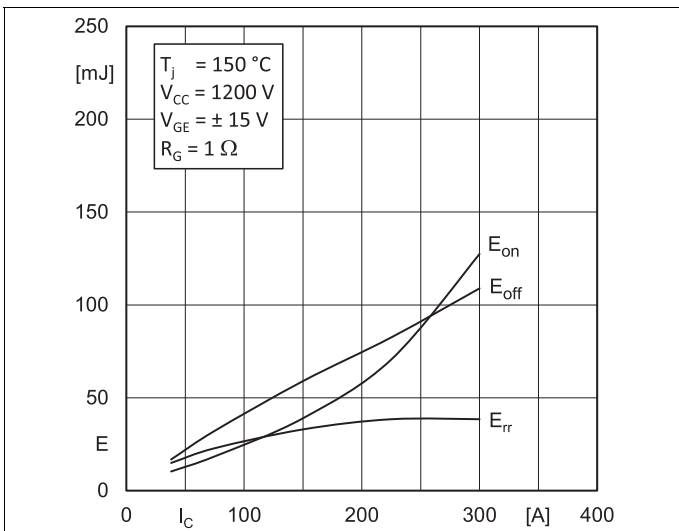


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

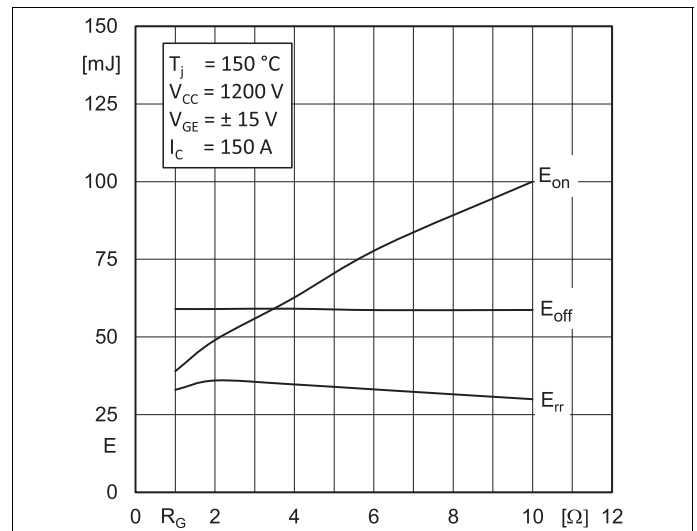


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

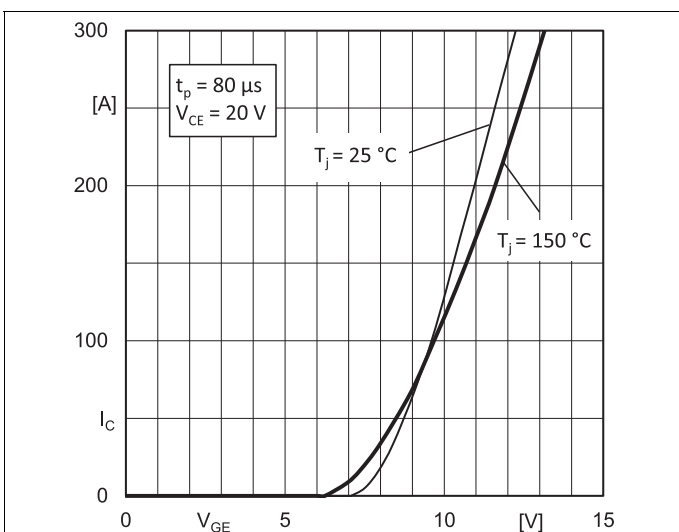


Fig. 5: Typ. transfer characteristic

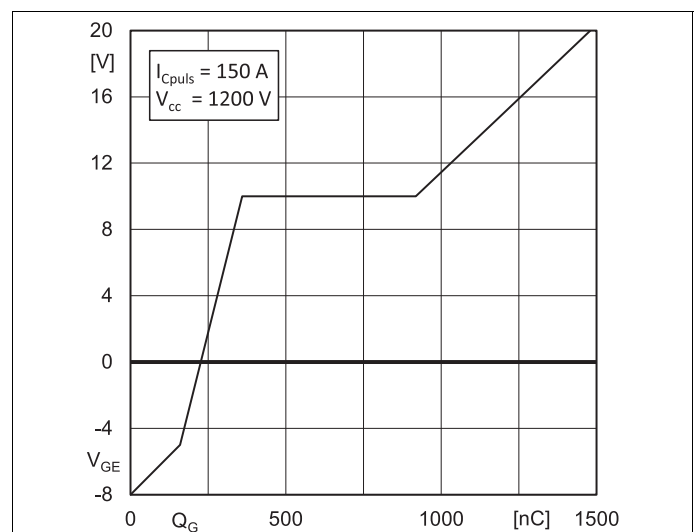


Fig. 6: Typ. gate charge characteristic

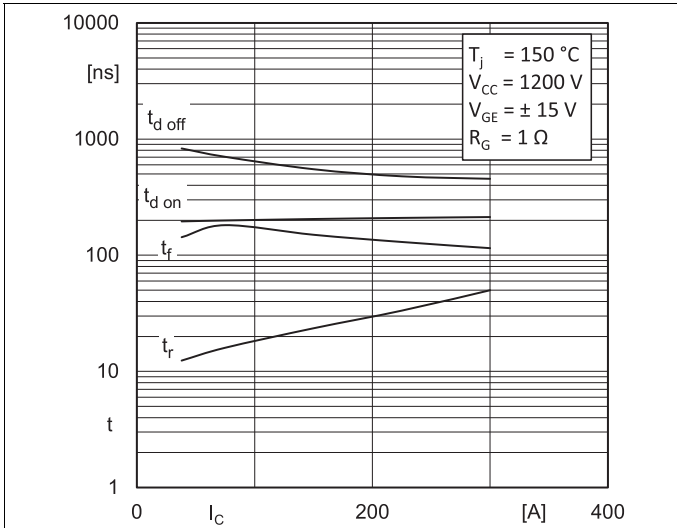


Fig. 7: Typ. switching times vs. I_C

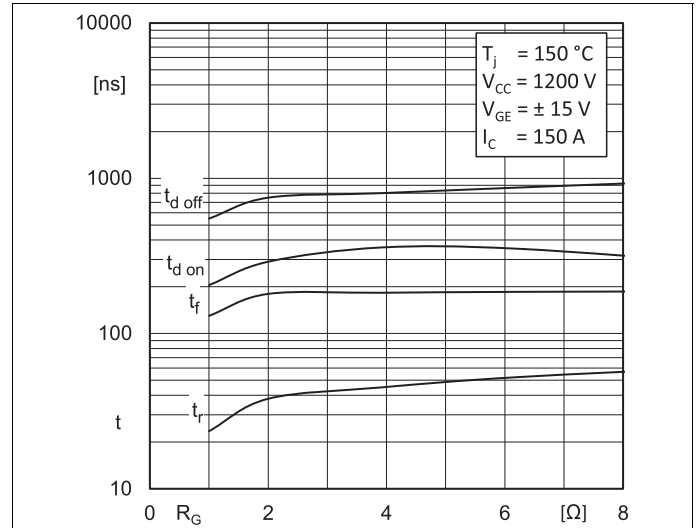


Fig. 8: Typ. switching times vs. gate resistor R_G

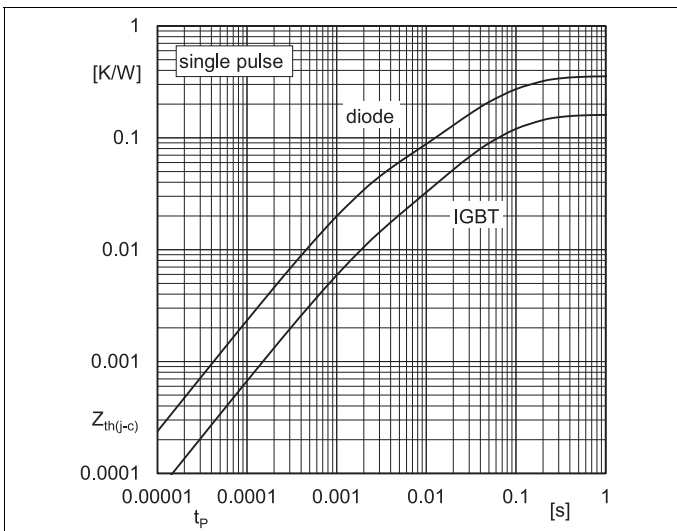


Fig. 9: Transient thermal impedance

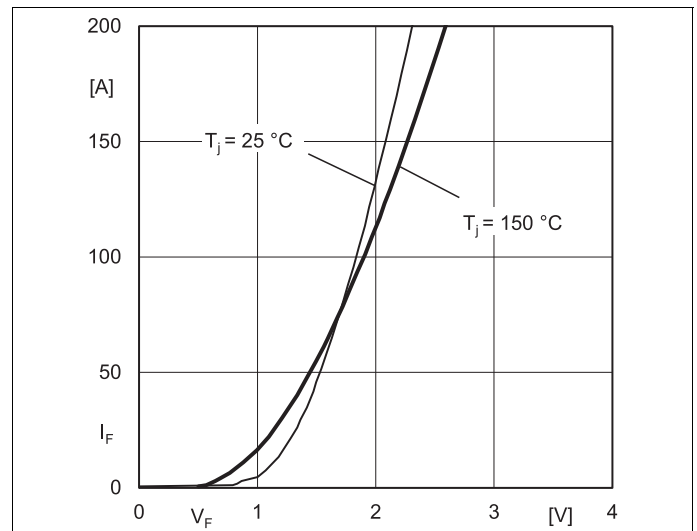
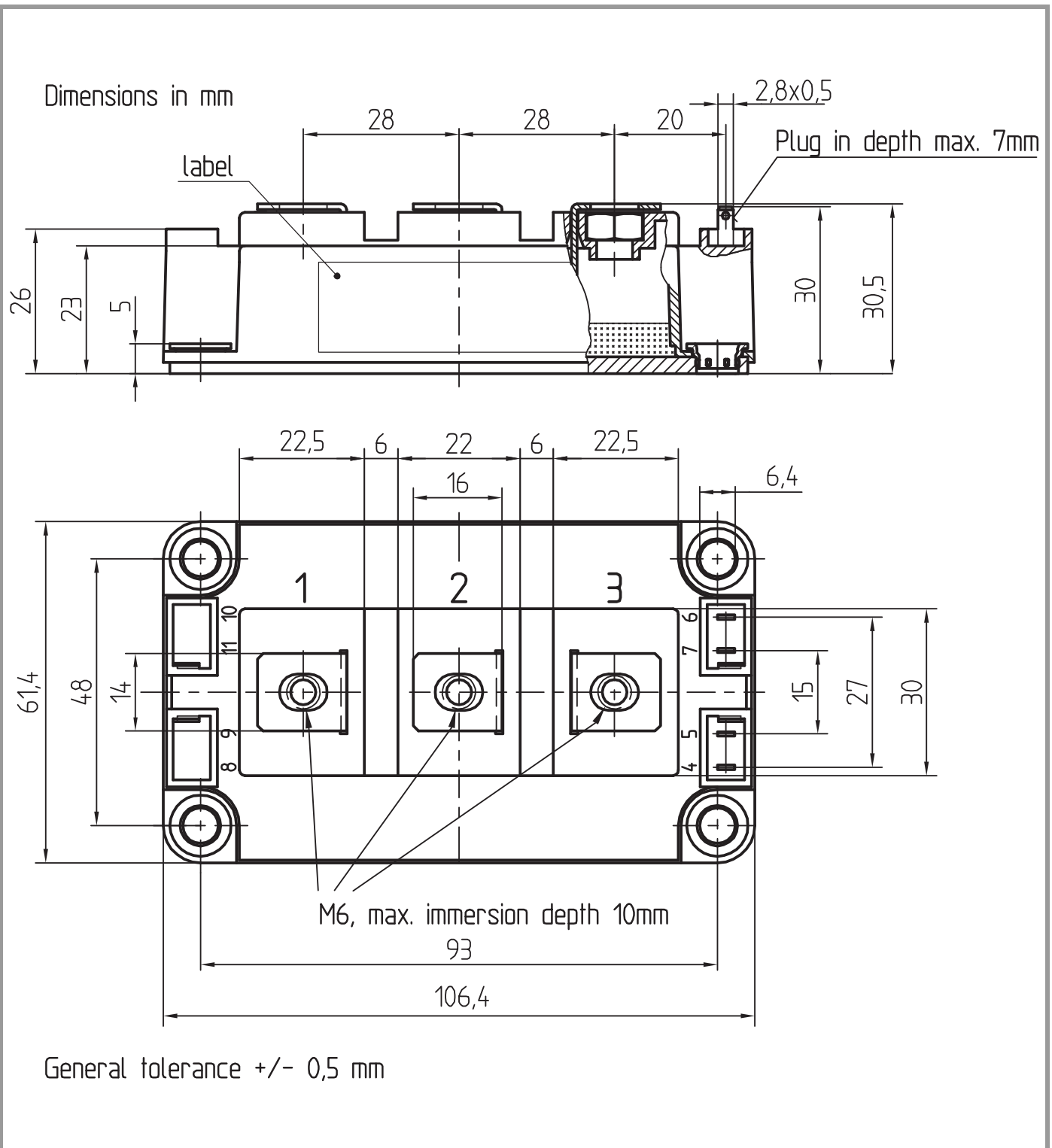
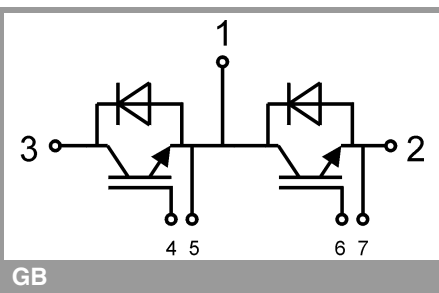


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC+EE'}$

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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

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